



Intelligence Systems and Sensors II

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Message from the Collection Editor

Dear Colleagues,

I would like to cordially invite you to contribute a paper to a Special Issue of the open access journal *Applied Sciences*, entitled “Intelligent Systems and Sensors”, which aims to present recent developments in fuzzy, neural networks and artificial intelligence in numerous fields of real-life importance, including robots, social systems, and industries, to name but a few.

This Special Issue will focus on fuzzy, neural networks; neuro-fuzzy systems; and intelligent systems and sensors based on artificial intelligence. I invite you to submit your research on these topics as either original research papers or articles.

Prof. Dr. Youngchul Bae





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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